



NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.
2. MATERIAL MUST COMPLY WITH BANNED AND RESTRICTED SUBSTANCES SPEC # 10-0131.
3. THE BASIC SOLDER BALL GRID PITCH IS 1.27 MM.
- ④ PRIMARY DATUM \square AND SEATING PLANES ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- ⑤ A1 CORNER MUST BE IDENTIFIED BY LASER MARK ON TOP PACKAGE.
6. ALL DIMENSIONS APPLY TO LEADED (-), LEAD FREE (+) PKG. CODES.
7. PACKAGE CODE: V36-1



TITLE: PACKAGE OUTLINE, 36 BALLS PBGA , W/ CRYSTAL 11.43x10.16x3.16mm, 1.27mm PITCH, 2 LAYER			
APPROVAL EDEN CHEN 09/06/10	DOCUMENT CONTROL NO. 21-0363	REV. B	1/1